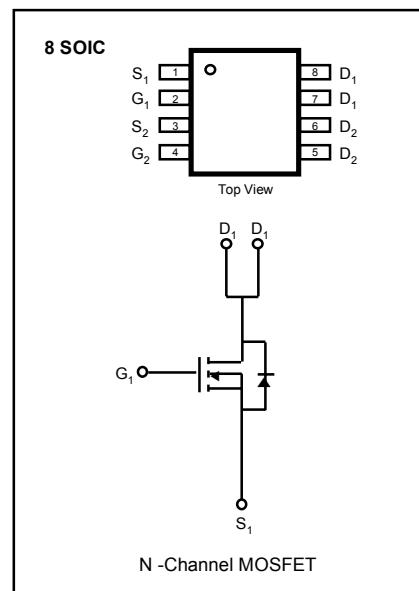


## FEATURES

- Lower  $R_{DS(ON)}$
- Improved Inductive Ruggedness
- Fast Switching Times
- Low Input Capacitance
- Extended Safe Operating Area
- Improved High Temperature Reliability

## Product Summary

Part Number	BVdss	Rds(on)	$I_D$
SSD2021	30V	0.05Ω	5.0A



## Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
$V_{DSS}$	Drain-to-Source Voltage	30	V
$I_D$	Continuous Drain Current $T_A=25^\circ C$	5.0	A
	Continuous Drain Current $T_A=70^\circ C$	4.0	
$I_{DM}$	Drain Current-Pulsed ①	40	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$P_D$	Total Power Dissipation ( $T_A=25^\circ C$ )	2.0	W
	( $T_A=70^\circ C$ )	1.3	
$T_J, T_{STG}$	Operating and Junction Storage Temperature Range	- 55 to + 150	°C

## Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	°C/W



**Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise specified)**

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	30	--	--	V	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	1.0	--	--	V	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=250\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage , Forward	--	--	100	nA	$\text{V}_{\text{GS}}=20\text{V}$
	Gate-Source Leakage , Reverse	--	--	-100	nA	$\text{V}_{\text{GS}}=-20\text{V}$
$\text{I}_{\text{DSS}}$	Drain-to-Source Leakage Current	--	--	1.0	$\mu\text{A}$	$\text{V}_{\text{DS}}=24\text{V}$
		--	--	5.0		$\text{V}_{\text{DS}}=24\text{V}, \text{T}_C=55^\circ\text{C}$
$\text{I}_{\text{DON}}$	On-State Drain-Source Current	20	--	--	A	$\text{V}_{\text{DS}}=5\text{V}, \text{V}_{\text{GS}}=10\text{V}$
$\text{R}_{\text{DS(on)}}$	Static Drain-Source On-State Resistance <sup>(2)</sup>	--	0.031	0.05	$\Omega$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=5.0\text{A}$
	On-State Resistance <sup>(2)</sup>	--	0.042	0.08		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=3.9\text{A}$
$\text{g}_{\text{fs}}$	Forward Transconductance <sup>(2)</sup>	--	8.0	--	$\text{S}$	$\text{V}_{\text{DS}}=15\text{V}, \text{I}_D=5.0\text{A}$
$t_{\text{d(on)}}$	Turn-On Delay Time	--	16	30	ns	$\text{V}_{\text{DD}}=15\text{V}, \text{I}_D=1.0\text{A}, \text{V}_{\text{GS}}=10\text{V}$
$t_r$	Rise Time	--	18	40		
$t_{\text{d(off)}}$	Turn-Off Delay Time	--	38	50		
$t_f$	Fall Time	--	24	50		
$\text{Q}_g$	Total Gate Charge	--	18	35	nC	$\text{V}_{\text{DS}}=10\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=5.0\text{A}$
$\text{Q}_{\text{gs}}$	Gate-Source Charge	--	3.5	--		
$\text{Q}_{\text{gd}}$	Gate-Drain( " Miller " ) Charge	--	3.5	--		

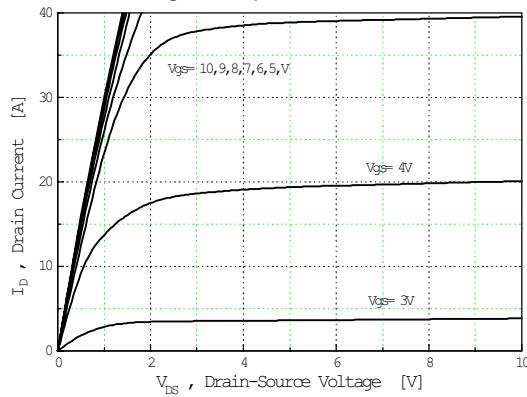
**Source-Drain Diode Ratings and Characteristics**

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$\text{I}_s$	Continuous Source Current (Body Diode)	--	--	1.7	A	Modified MOSFET Symbol Showing the Integral Reverse P-N Junction Rectifier 
$\text{V}_{\text{SD}}$	Diode Forward Voltage <sup>(2)</sup>	--	--	1.2	V	$\text{T}_A=25^\circ\text{C}, \text{I}_s=1.7\text{A}, \text{V}_{\text{GS}}=0\text{V}$
$t_{\text{rr}}$	Reverse Recovery Time <sup>(2)</sup>	--	120	160	ns	$\text{T}_A=25^\circ\text{C}, \text{I}_F=1.7\text{A}, \text{di}_F/\text{dt}=100\text{A}/\mu\text{s}$

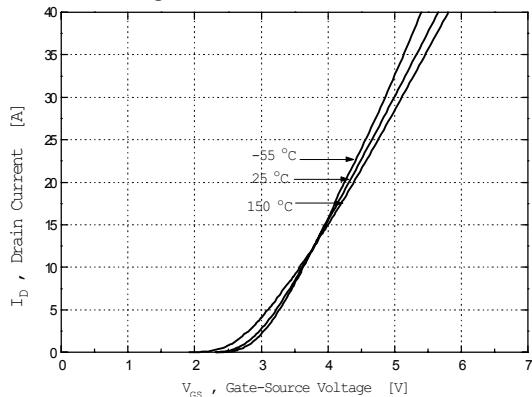
**Notes :**

- <sup>(1)</sup> Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- <sup>(2)</sup> Pulse Test : Pulse Width = 250 $\mu\text{s}$ , Duty Cycle  $\leq 2\%$
- <sup>(3)</sup> Essentially Independent of Operating Temperature

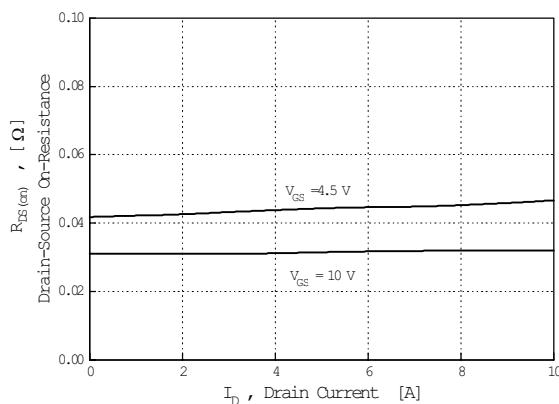
**Fig 1. Output Characteristics**



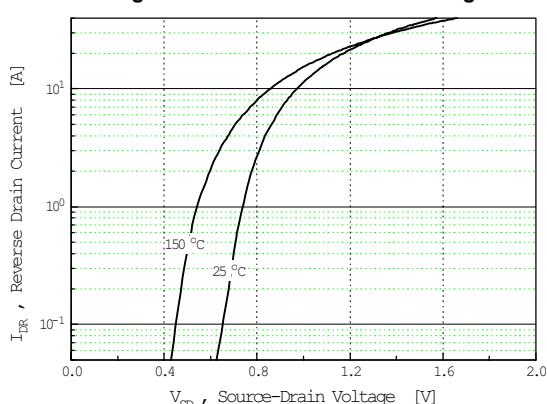
**Fig 2. Transfer Characteristics**



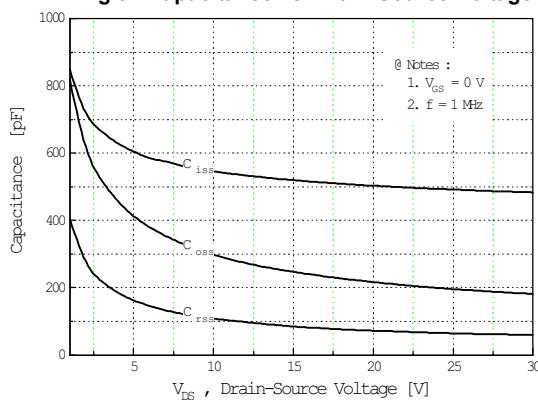
**Fig 3. On-Resistance vs. Drain Current**



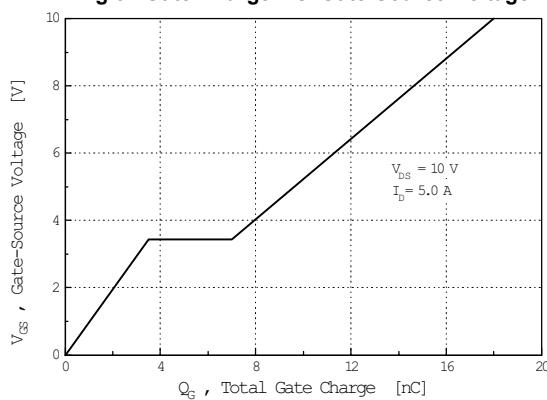
**Fig 4. Source-Drain Forward Voltage**



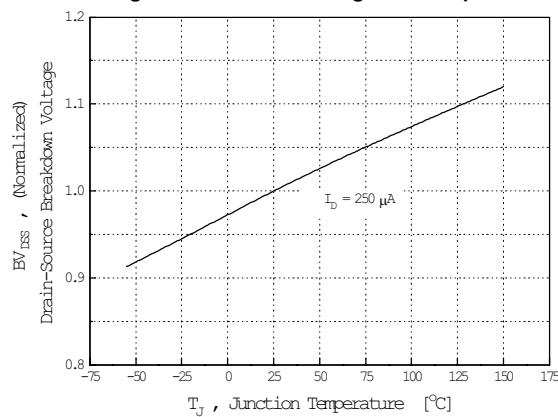
**Fig 5. Capacitance vs. Drain-Source Voltage**



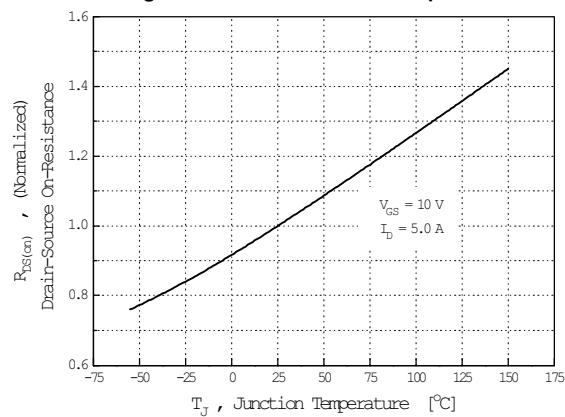
**Fig 6. Gate Charge vs. Gate-Source Voltage**



**Fig 7. Breakdown Voltage vs. Temperature**



**Fig 8. On-Resistance vs. Temperature**



**Fig 9. Normalized Effective Transient Thermal Impedance, Junction-to-Ambient**

